

2.5x0.7mm RIGHT ANGLE SMD CHIP LED LAMP



Features

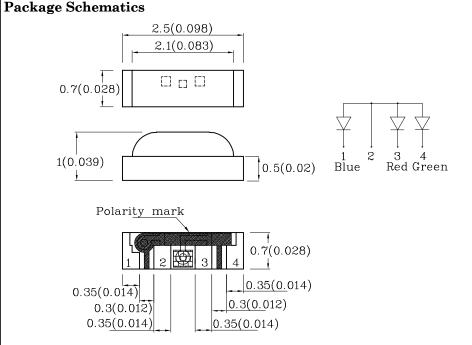
- 2.5x0.7x1.0mm right angle SMD LED
- Ideal for indication on hand held products
- Low current operation
- Standard Package: 3,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- RoHS compliant







ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES



Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.15 (0.006")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T_A =25°C)		Blue Red (AlGal N) nP)		Green (InGa N)	Unit
Reverse Voltage	$V_{\rm R}$	5	5	5	V
Forward Current	I_{F}	30	30	25	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i_{FS}	150	195	150	mA
Power Dissipation	P_{D}	120	75	102.5	mW
Electrostatic Discharge Thre (HBM)	250	3000	450	V	
Operating Temperature T_A				°C	
Storage Temperature	Tstg	-40 ~ +85			

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T _A =25°C)	Blue (InGa N)	Red (AlGaI nP)	Green (InGa N)	Unit	
Forward Voltage (Typ.) (I _F =20mA)	V_{F}	3.3	2	3.3	V
Forward Voltage (Max.) (I _F =20mA)	V_{F}	4	2.5	4.1	V
Reverse Current (Max.) (V _R =5V)	I_R	50	10	50	μA
Wavelength of Peak Emission CIE127-2007*(Typ.) (I _F =20mA)	λР	460*	630*	515*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I _F =20mA)	λD	465*	621*	525*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	Δλ	25	20	35	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	100	25	45	pF

Part Number	Emitting Color	Emitting Material	Lens-color	$\begin{array}{c} \text{Luminous Intensity} \\ \text{CIE127-2007*} \\ \text{(I}_{\text{F}}\text{=}20\text{mA}) \\ \text{mcd} \end{array}$		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
	Blue	InGaN		40*	64*	460*	
XZCBDMEDGK161W	Red	AlGaInP	Water Clear	80*	108*	630*	130°
•	Green	InGaN	•	300*	497*	515*	

^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

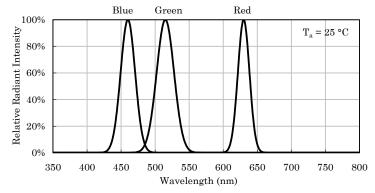
Feb 26,2019



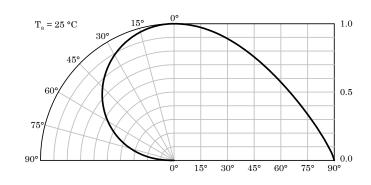






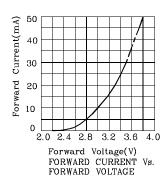


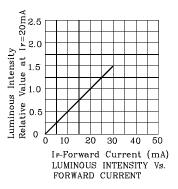
Relative Intensity Vs. CIE Wavelength

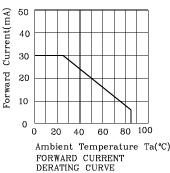


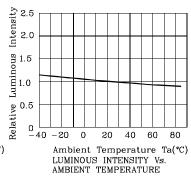
Spatial Distribution

❖ Blue

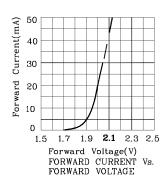


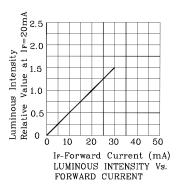


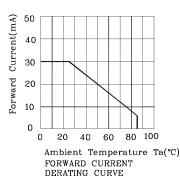


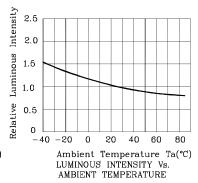


❖ Red

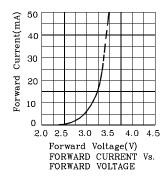


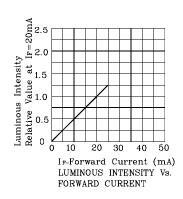


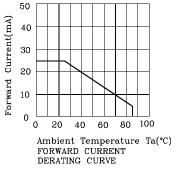


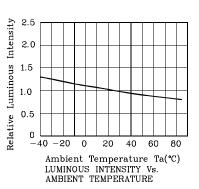


* Green







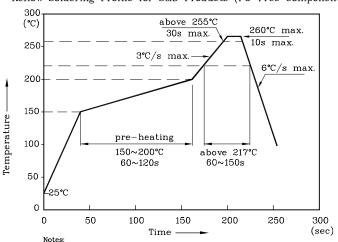


XDSB8191 V4-Z Layout: Maggie L.



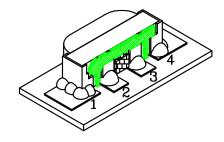
❖ LED is recommended for reflow soldering and soldering profile is shown below.

Reflow Soldering Profile for SMD Products (Pb-Free Components)

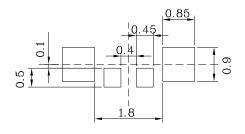


- All temperatures refer to the center of the package, measured on the package body surface facing up during reflow.
- 2. Do not apply any stress to the LED during high temperature conditions.
- 3. Maximum number of soldering passes: 2

❖ The device has a single mounting surface. The device must be mounted according to the specifications.

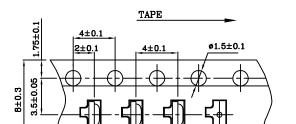


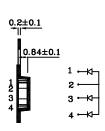
❖ Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

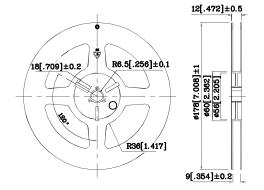


Reel Dimension

❖ Tape Specification (Units:mm)







Remarks:

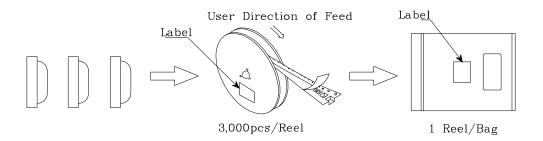
If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

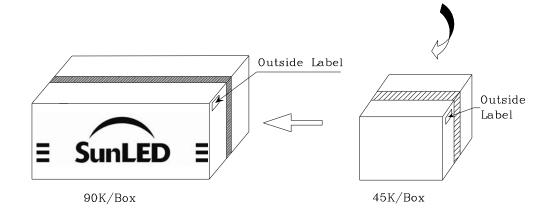
- 1. Wavelength: +/-1nm
- 2. Luminous intensity / luminous flux: +/-15%
- 3. Forward Voltage: +/-0.1V

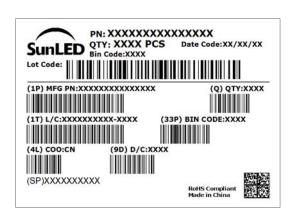
Note: Accuracy may depend on the sorting parameters.



PACKING & LABEL SPECIFICATIONS







TERMS OF USE

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- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
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- 6. Additional technical notes are available at https://www.SunLEDusa.com/TechnicalNotes.asp

Feb 26,2019 XDSB8191 V4-Z Layout: Maggie L.